

# GB2X100MPS12-227

1200V 200A SiC Schottky MPS™ Diode



## Silicon Carbide Schottky Diode

$V_{RRM}$	=	1200 V
$I_F (T_C = 100^\circ\text{C})$	=	304 A *
$Q_C$	=	220 nC *

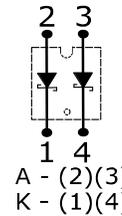
### Features

- High Avalanche (UIS) Capability
- Enhanced Surge Current Capability
- Superior Figure of Merit  $Q_C/I_F$
- 3000 V Isolation with Low Thermal Resistance
- 175 °C Maximum Operating Temperature
- Temperature Independent Switching Behavior
- Positive Temperature Coefficient of  $V_F$
- Extremely Fast Switching Speed

### Advantages

- Low Standby Power Losses
- Improved Circuit Efficiency (Lower Overall Cost)
- Low Switching Losses
- Ease of Paralleling without Thermal Runaway
- Smaller Heat Sink Requirements
- Low Reverse Recovery Current
- Low Device Capacitance
- Low Reverse Leakage Current

### Package



SOT-227 (Isolated Base)



### Applications

- Boost Diode in Power Factor Correction (PFC)
- Switched Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Motor Drives
- Freewheeling / Anti-parallel Diode in Inverters
- Solar Inverters
- Electric Vehicles (EV) & DC Fast Charging
- Induction Heating & Welding

### Absolute Maximum Ratings (At $T_C = 25^\circ\text{C}$ Unless Otherwise Stated)

Parameter	Symbol	Conditions	Values	Unit
Repetitive Peak Reverse Voltage (Per Leg)	$V_{RRM}$		1200	V
Continuous Forward Current (Per Leg / Per Device)	$I_F$	$T_C = 25^\circ\text{C}, D = 1$	228 / 456	A
		$T_C = 100^\circ\text{C}, D = 1$	152 / 304	
		$T_C = 138^\circ\text{C}, D = 1$	100 / 200	
Non-Repetitive Peak Forward Surge Current, Half Sine Wave (Per Leg)	$I_{F,SM}$	$T_C = 25^\circ\text{C}, t_P = 10\text{ ms}$	800	A
		$T_C = 150^\circ\text{C}, t_P = 10\text{ ms}$	640	
Repetitive Peak Forward Surge Current, Half Sine Wave (Per Leg)	$I_{F,RM}$	$T_C = 25^\circ\text{C}, t_P = 10\text{ ms}$	480	A
		$T_C = 150^\circ\text{C}, t_P = 10\text{ ms}$	336	
Non-Repetitive Peak Forward Surge Current (Per Leg)	$I_{F,max}$	$T_C = 25^\circ\text{C}, t_P = 10\text{ }\mu\text{s}$	4000	A
$i^2t$ Value (Per Leg)	$\int i^2 dt$	$T_C = 25^\circ\text{C}, t_P = 10\text{ ms}$	3200	$\text{A}^2\text{s}$
Non-Repetitive Avalanche Energy (Per Leg)	$E_{AS}$	$L = 0.3\text{ mH}, I_{AS} = 100\text{ A}$	1200	mJ
Diode Ruggedness (Per Leg)	$dV/dt$	$V_R = 0 \sim 960\text{ V}$	200	V/ns
Power Dissipation (Per Leg / Per Device)	$P_{tot}$	$T_C = 25^\circ\text{C}$	777 / 1554	W
Operating and Storage Temperature	$T_j, T_{stg}$		-55 to 175	$^\circ\text{C}$

\* Per Device

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## Electrical Characteristics (Per Leg)

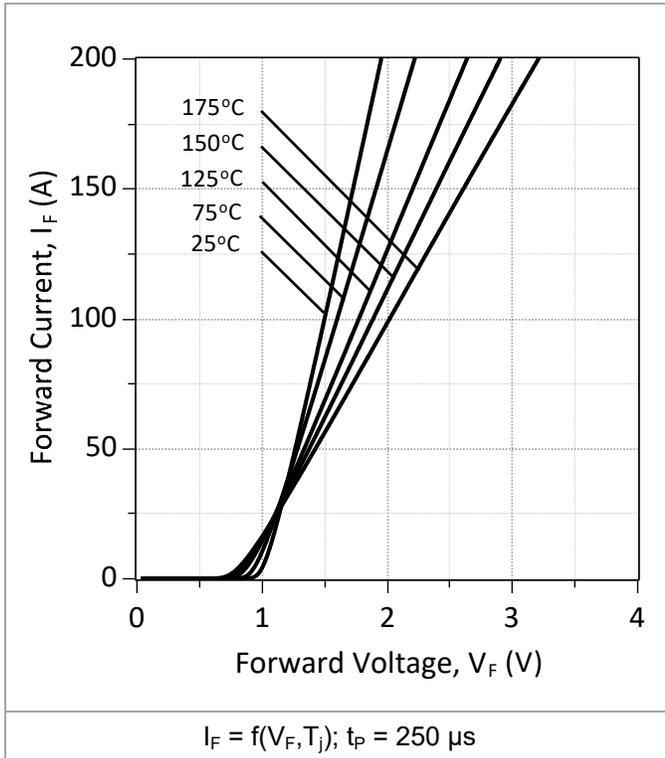
Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Diode Forward Voltage	$V_F$	$I_F = 100 \text{ A}, T_j = 25 \text{ }^\circ\text{C}$		1.5	1.8	V
		$I_F = 100 \text{ A}, T_j = 175 \text{ }^\circ\text{C}$		2	2.4	
Reverse Current	$I_R$	$V_R = 1200 \text{ V}, T_j = 25 \text{ }^\circ\text{C}$		10	50	$\mu\text{A}$
		$V_R = 1200 \text{ V}, T_j = 175 \text{ }^\circ\text{C}$		100	500	
Total Capacitive Charge	$Q_C$	$I_F \leq I_{F,MAX}$ $di_F/dt = 200 \text{ A}/\mu\text{s}$ $T_j = 175 \text{ }^\circ\text{C}$	$V_R = 400 \text{ V}$	156		nC
			$V_R = 800 \text{ V}$	220		
Switching Time	$t_s$	$V_R = 400 \text{ V}$ $V_R = 800 \text{ V}$		< 10		ns
Total Capacitance	C	$V_R = 1 \text{ V}, f = 1 \text{ MHz}$		452		pF
		$V_R = 800 \text{ V}, f = 1 \text{ MHz}$		326		

## Thermal / Package Characteristics

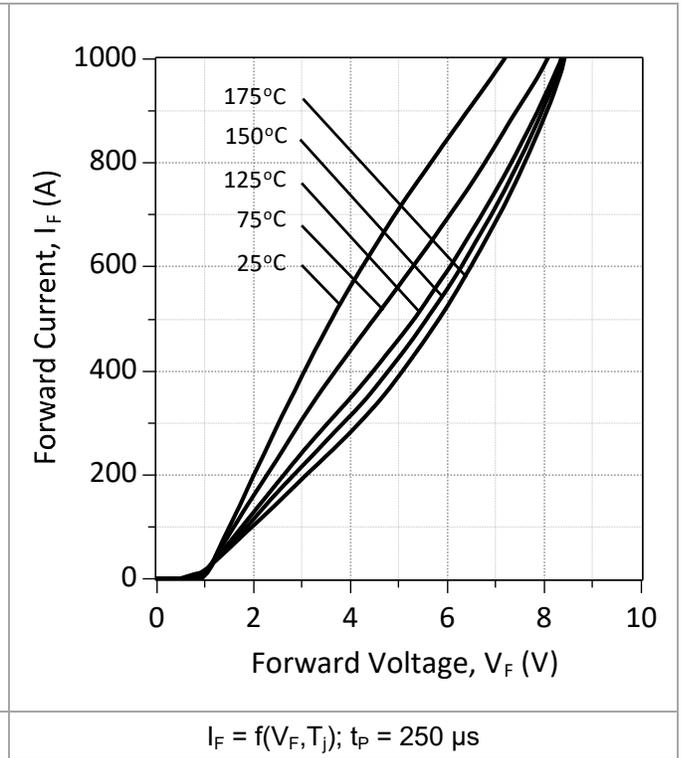
Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Thermal Resistance, Junction – Case (Per Leg)	$R_{thJC}$			0.193		$^\circ\text{C}/\text{W}$
Weight	$W_T$			28		g
Mounting Torque	$T_M$	Screws to Heatsink			1.5	Nm
		Terminal Connection (M4)			1.3	
Isolation Voltage (RMS)	$V_{ISO}$	$t = 1 \text{ s (50 / 60 Hz)}$	3000			V
		$t = 60 \text{ s (50 / 60 Hz)}$	2500			
Creepage Distance on Surface	$d_{Ctt}$	Terminal to Terminal	10.5			mm
	$d_{Ctb}$	Terminal to Backside	8.5			
Striking Distance Through Air	$d_{Stt}$	Terminal to Terminal	3.2			mm
	$d_{Stb}$	Terminal to Backside	6.8			

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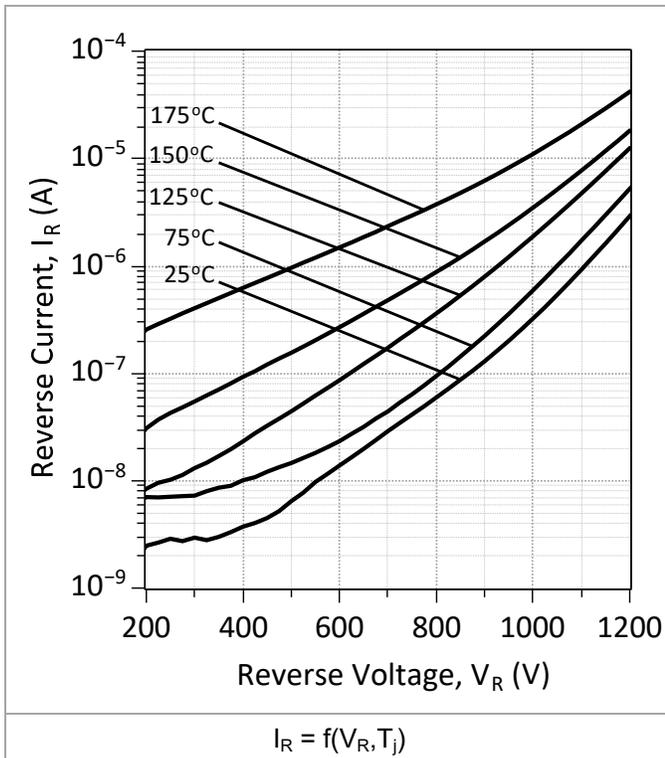
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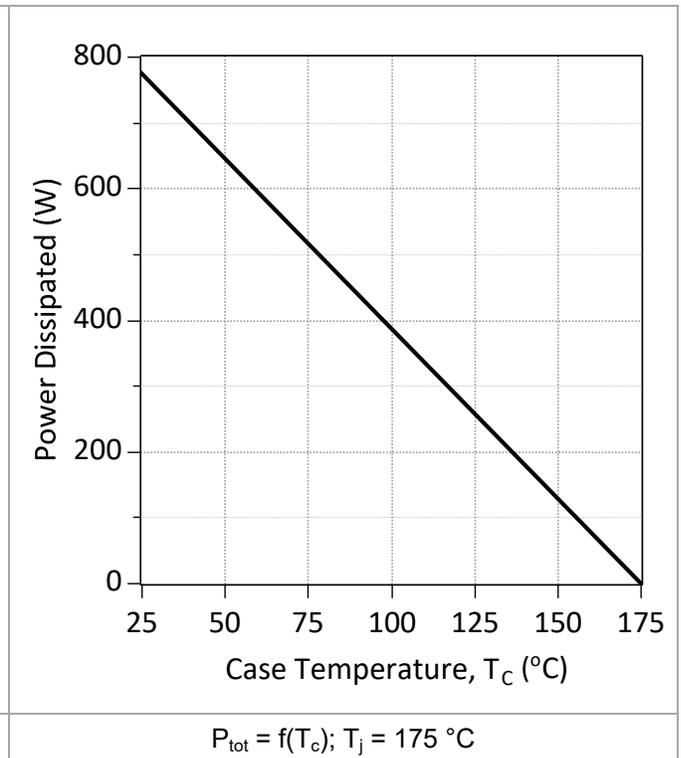
**Figure 1: Typical Forward Characteristics (Per Leg)**



**Figure 2: Typical High Current Forward Characteristics (Per Leg)**



**Figure 3: Typical Reverse Characteristics (Per Leg)**



**Figure 4: Power Derating Curve (Per Leg)**

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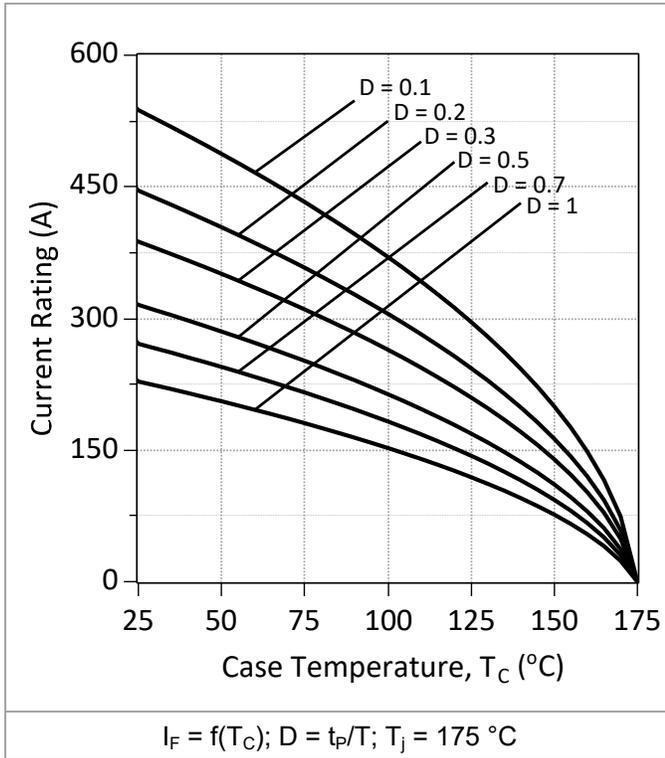


Figure 5: Current Derating Curves (Per Leg)

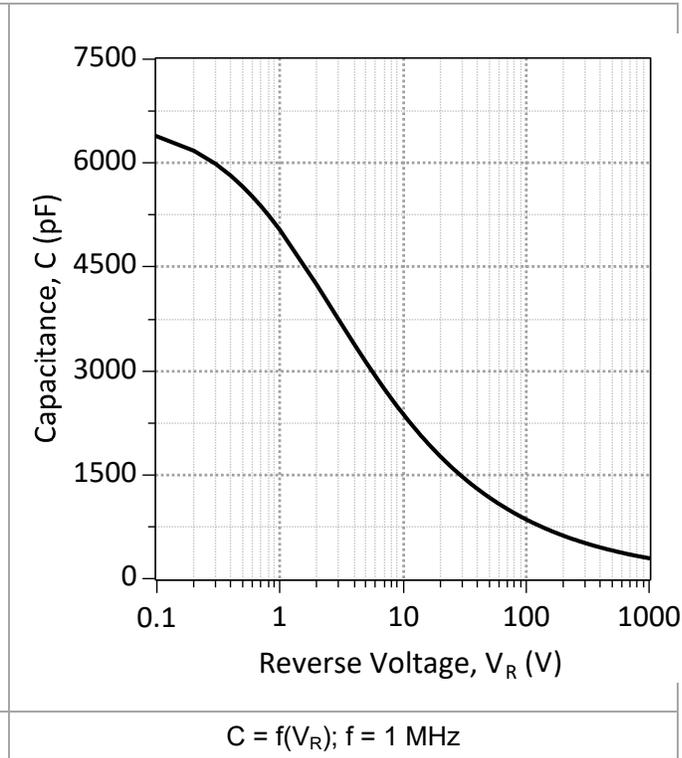


Figure 6: Typical Junction Capacitance vs. Reverse Voltage Characteristics (Per Leg)

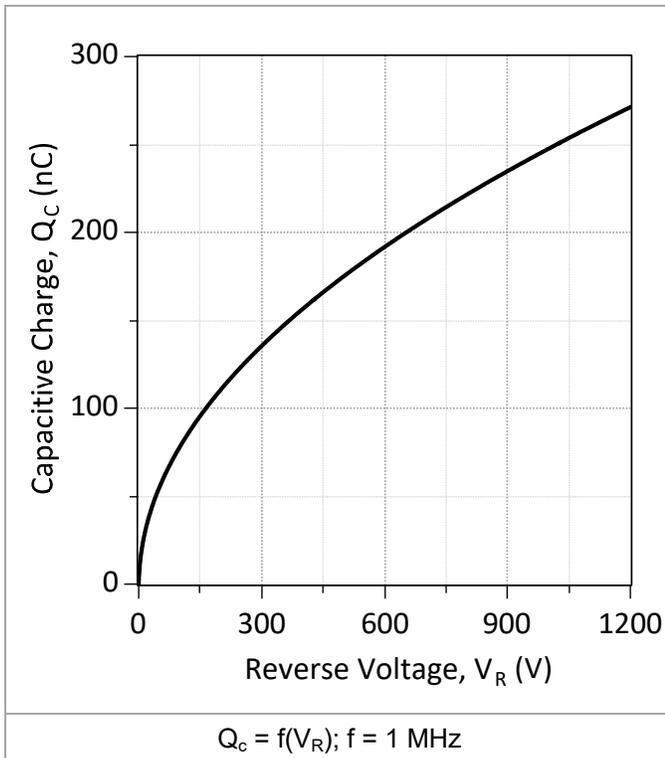


Figure 7: Typical Capacitive Charge vs. Reverse Voltage Characteristics (Per Leg)

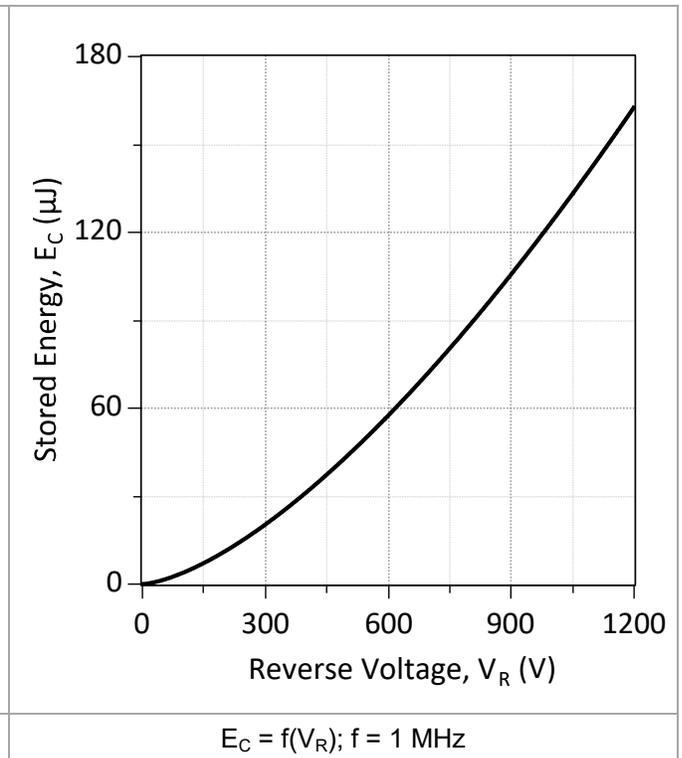


Figure 8: Typical Capacitive Energy vs. Reverse Voltage Characteristics (Per Leg)

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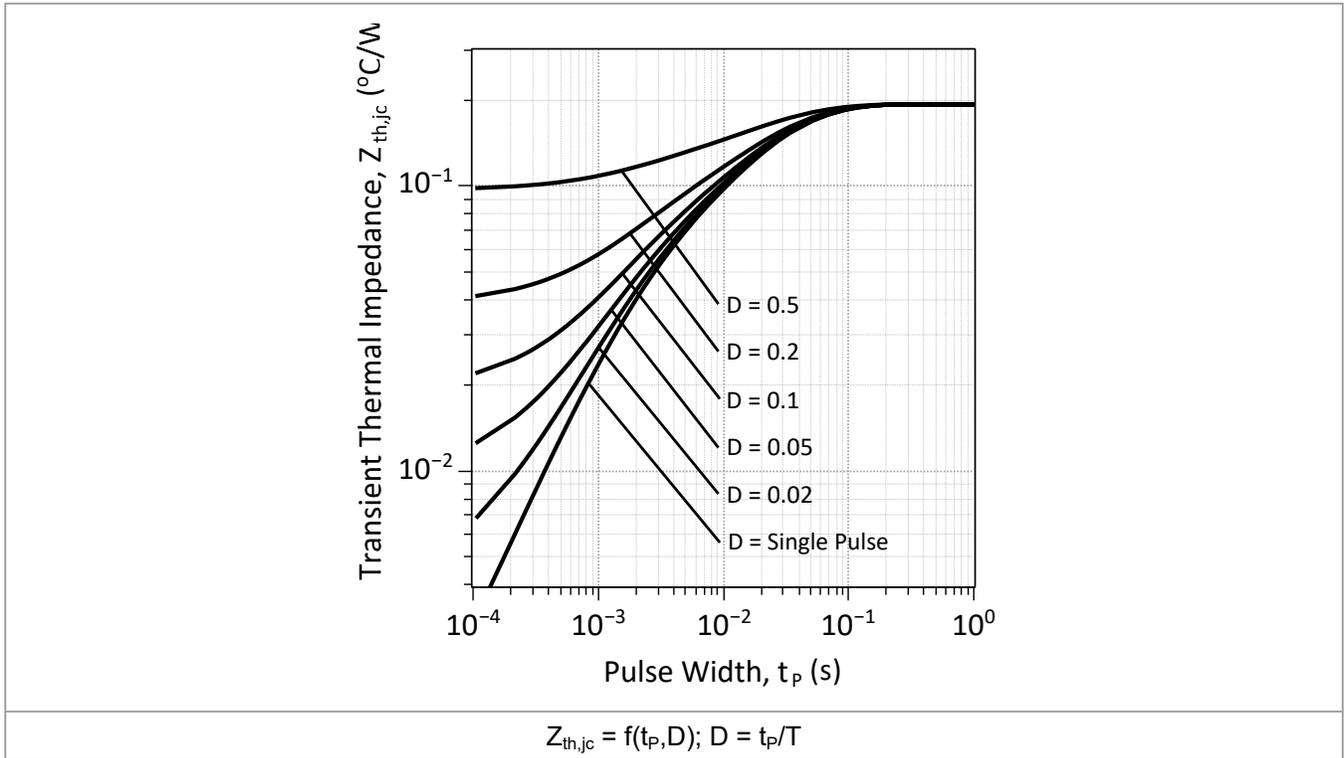
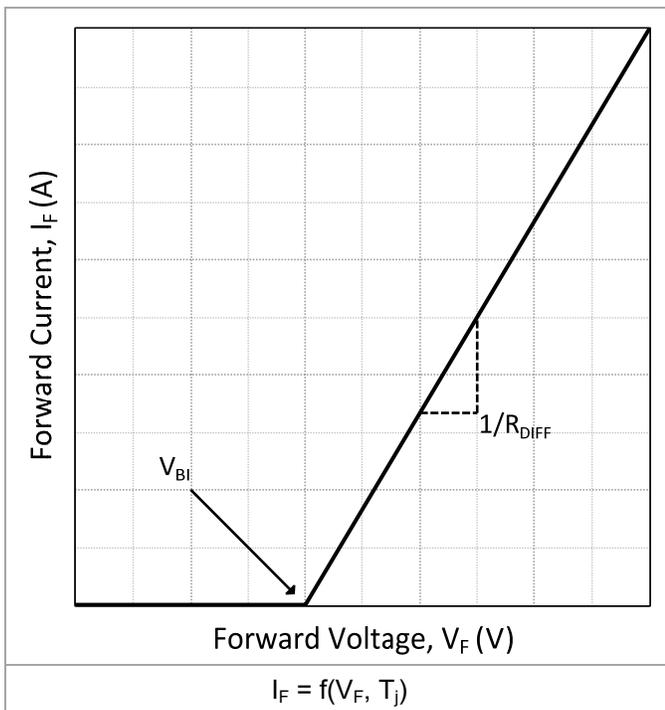


Figure 9: Transient Thermal Impedance (Per Leg)



$$I_F = (V_F - V_{Bi})/R_{DIFF} \text{ (A)}$$

**Built-In Voltage ( $V_{Bi}$ ):**

$$V_{Bi}(T_j) = m \cdot T_j + n \text{ (V)},$$

$$m = -1.47e-03, n = 1.08$$

**Differential Resistance ( $R_{DIFF}$ ):**

$$R_{DIFF}(T_j) = a \cdot T_j^2 + b \cdot T_j + c \text{ (}\Omega\text{);}$$

$$a = 2.87e-07, b = 3.40e-05, c = 0.0076$$

Figure 10: Forward Curve Model (Per Leg)

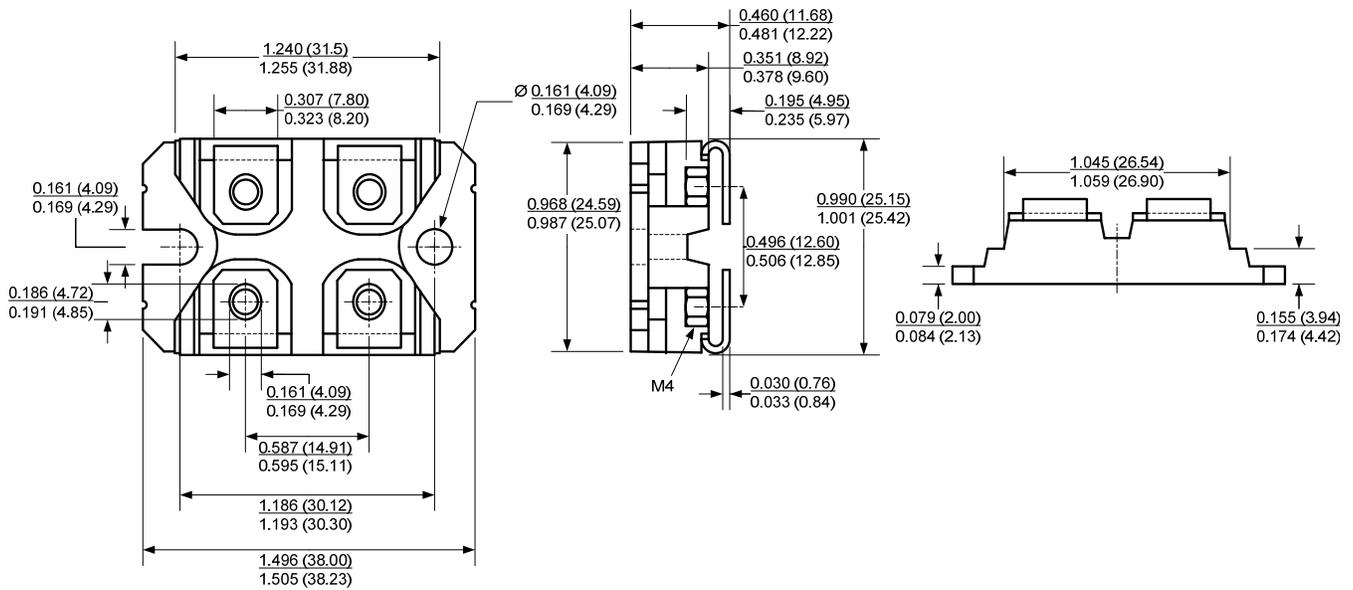
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**Package Dimensions**

**SOT-227**

**Package Outline**



**NOTE**

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS

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### RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS 2), as adopted by EU member states on January 2, 2013 and amended on March 31, 2015 by EU Directive 2015/863. RoHS Declarations for this product can be obtained from your GeneSiC representative.

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- SPICE Models: <https://www.genesicsemi.com/schottky-mps>
- Evaluation Boards: <https://www.genesicsemi.com/technical-support>
- Quality Manual: <https://www.genesicsemi.com/technical-support/quality-manual>
- Compliance: <https://www.genesicsemi.com/technical-support/compliance>
- Reliability Report: <https://www.genesicsemi.com/technical-support/reliability>

[www.genesicsemi.com/schottky-mps](https://www.genesicsemi.com/schottky-mps)



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